

MOSFET

OptiMOS™ 6 Power-Transistor, 40 V

Features

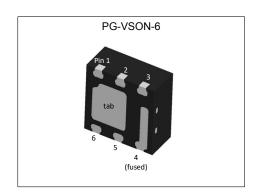
- N-channel, logic level
- Lowest on-resistance R_{DS(on)} in a 2x2 package
 Superior thermal resistance for a 2x2 package
- 100% avalanche tested
- Pb-free lead plating; RoHS compliantHalogen-free according to IEC61249-2-21
- Optimized for highest performance and power density

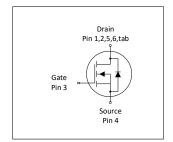
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit						
V _{DS}	40	V						
R _{DS(on), max}	5.75	mΩ						
I_D	64	A						
Qoss	11	nC						
Q _G (0V10V)	9.7	nC						











Type / Ordering Code	Package	Marking	Related Links
ISK057N04LM6	PG-VSON-6	5704	-

OptiMOS™ 6 Power-Transistor, 40 V ISK057N04LM6



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OptiMOS™ 6 Power-Transistor, 40 V ISK057N04LM6



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Damamatan	0	Values			Unit		
Parameter	Symbol	Min.	Тур.	Тур. Мах.		Note / Test Condition	
Continuous drain current ¹⁾	I _D	- - -	- - -	64 40 34 15	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =100 °C ²⁾ $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =60 °C/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	254	Α	<i>T</i> _C =25 °C	
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	17	mJ	$I_{\rm D}$ =20 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	39.1 2.1	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 °C/W ²⁾	
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	-	

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition	
Farameter	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition	
Thermal resistance, junction - case, bottom	R _{thJC}	_	1.6	3.2	°C/W	-	
Device on PCB, 6 cm² cooling area²)	R _{thJA}	-	-	60	°C/W	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperatureas specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actualenvironmental conditions. $^{2)}$ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

OptiMOS™ 6 Power-Transistor, 40 V ISK057N04LM6



3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

Bassassassas			Value	s			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	40	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	1.3	1.8	2.3	V	V _{DS} =V _{GS} , I _D =250 μA	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =40 V, V _{GS} =0 V, T _j =25 °C V _{DS} =40 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	5.1 6.9	5.75 8.3	mΩ	V _{GS} =10 V, I _D =20 A V _{GS} =4.5 V, I _D =20 A	
Gate resistance ¹⁾	R _G	-	0.7	1.2	Ω	-	
Transconductance	g fs	-	65	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 20 \text{ A}$	

Table 5 Dynamic characteristics

Devementar	Combal	Values			11!4	Nata / Tank Canalikian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance ¹⁾	Ciss	-	670	870	pF	V _{GS} =0 V, V _{DS} =20 V, f=1 MHz	
Output capacitance ¹⁾	Coss	-	220	290	pF	V _{GS} =0 V, V _{DS} =20 V, f=1 MHz	
Reverse transfer capacitance ¹⁾	C _{rss}	-	12	21	pF	V _{GS} =0 V, V _{DS} =20 V, f=1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	5.7	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω	
Rise time	t _r	-	2.9	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω	
Turn-off delay time	$t_{ m d(off)}$	-	9.5	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω	
Fall time	t _f	-	1.8	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω	

Table 6 Gate charge characteristics²⁾

Davamatav	Symbol		Values			Note / Took Condition	
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	Q _{gs}	-	1.9	-	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge at threshold	Q _{g(th)}	-	1.0	-	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	1.3	2.0	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V	
Switching charge	Q _{sw}	-	2.2	-	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total ¹⁾	Q g	-	9.7	12	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V	
Gate plateau voltage	V _{plateau}	-	2.9	-	V	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total	Q g	-	4.7	-	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V	
Gate charge total, sync. FET	Q _{g(sync)}	-	9.0	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V	
Output charge ¹⁾	Qoss	-	11	14	nC	V _{DD} =20 V, V _{GS} =0 V	

 $^{^{\}rm 1)}$ Defined by design. Not subject to production test. $^{\rm 2)}$ See "Gate charge waveforms" for parameter definition

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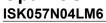


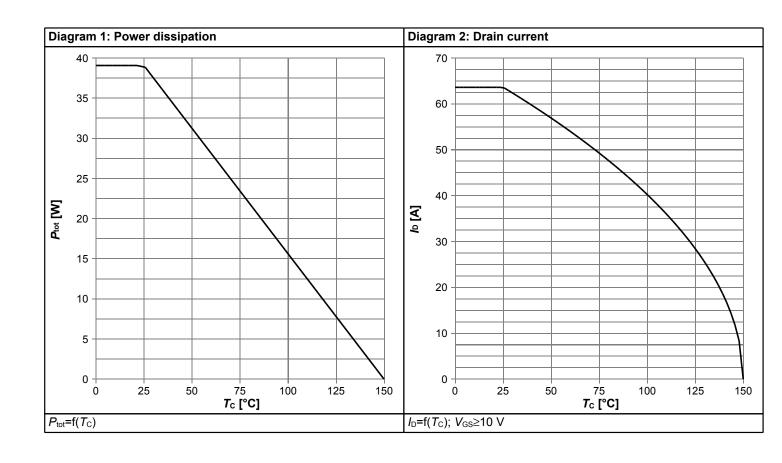


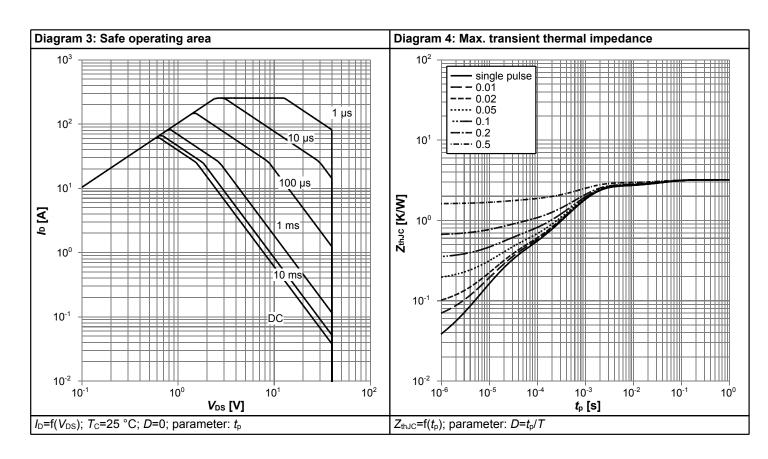
Table 7 Reverse diode

Davamatav	0		Values			Nata (Tast Ossalition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	36	Α	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	254	Α	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	0.84	1.0	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C	
Reverse recovery time ¹⁾	t _{rr}	-	48	96	ns	V_R =20 V, I_F =20 A, di_F/dt =100 A/ μ s	
Reverse recovery charge ¹⁾	Qrr	-	29	58	nC	V_R =20 V, I_F =20 A, di_F/dt =100 A/ μ s	
Reverse recovery time ¹⁾ t_{rr}		-	16	32	ns	V_R =20 V, I_F =20 A, di_F/dt =500 A/ μ s	
Reverse recovery charge ¹⁾ Q _{rr}		-	32	64	nC	V_R =20 V, I_F =20 A, di_F/dt =500 A/ μ s	

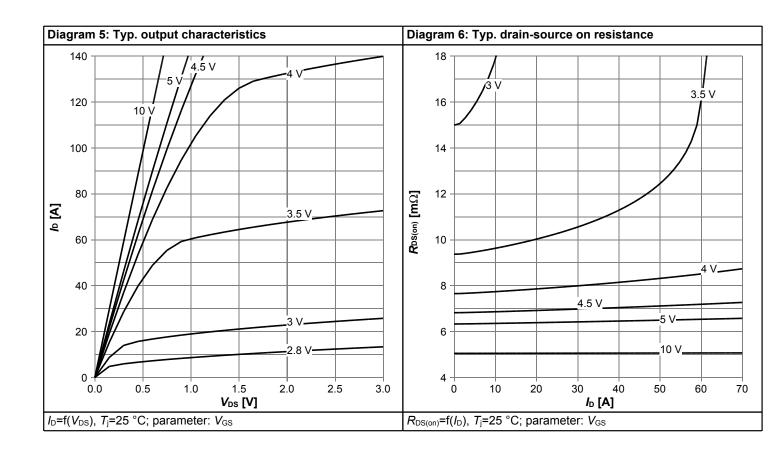


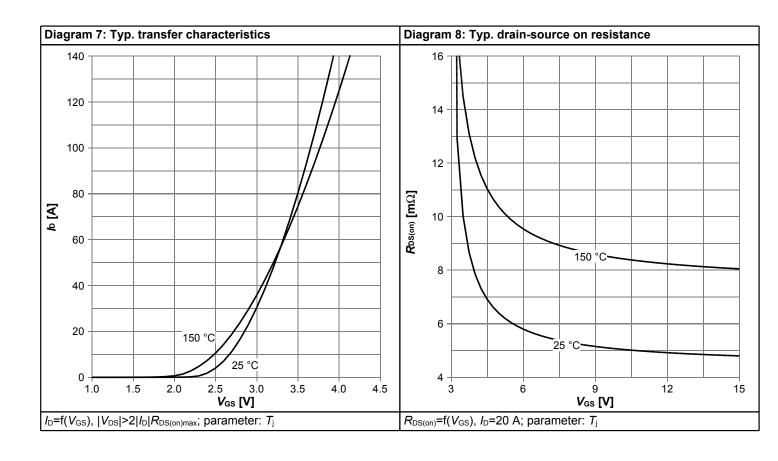
4 Electrical characteristics diagrams



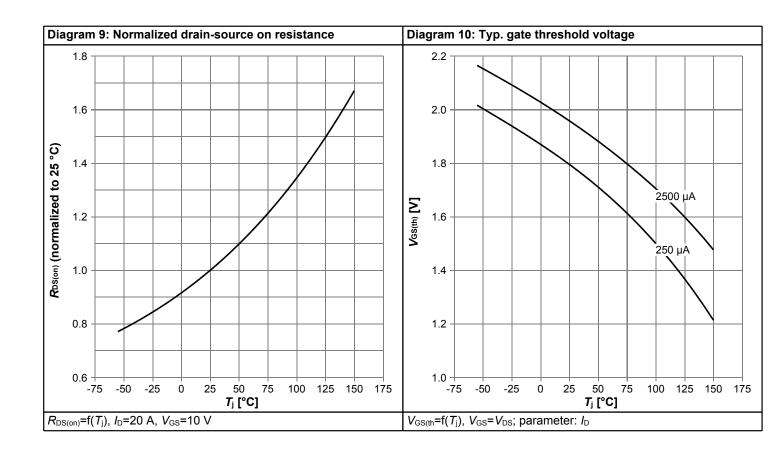


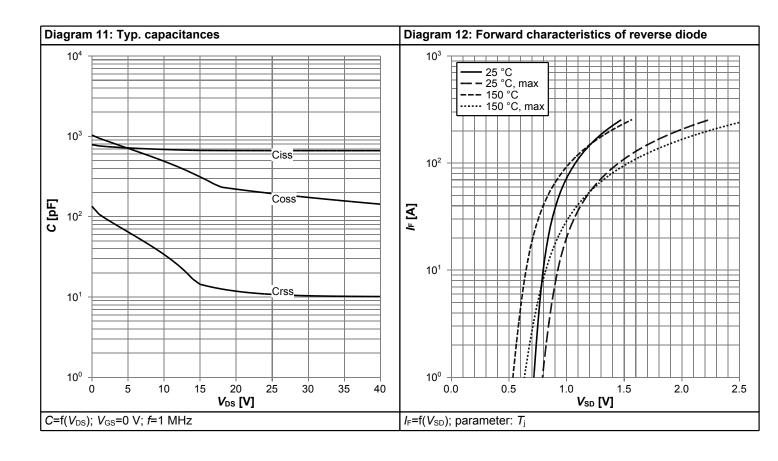




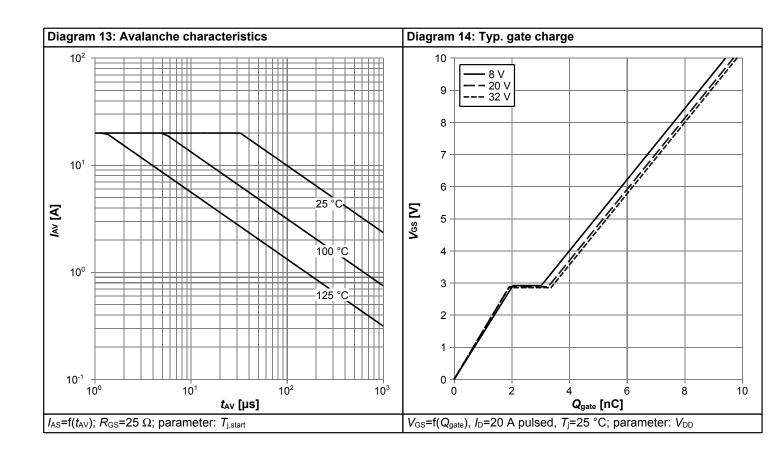


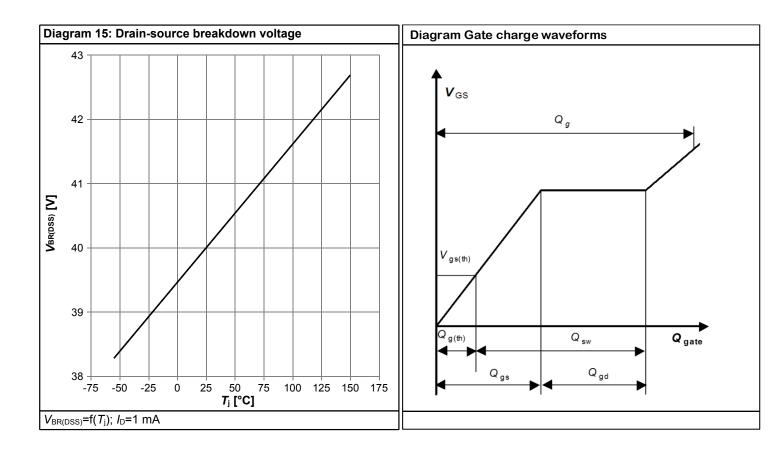






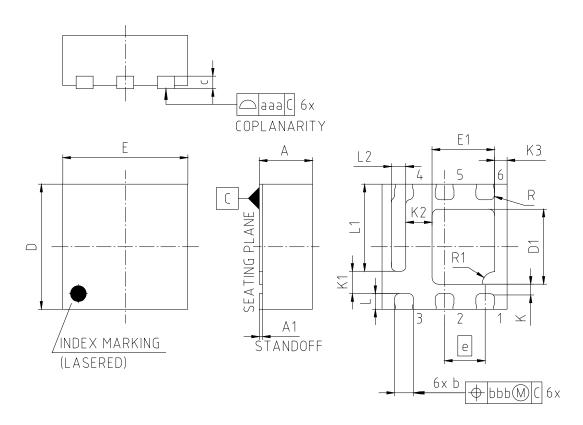








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-VSC	DN-6-U02			
DIMENSIONS	MILLIMETERS		DIMENSIONS	MILLIM	IETERS
DIMENSIONS	MIN.	MAX.	DIMENSIONS	MIN.	MAX.
Α		0.90	L	0.20	0.30
A1		0.05	L1	1.29	1.49
b	0.20	0.40	L2	0.13	0.33
С	(0.20)		R	(0.08)	
D	1.90	1.90 2.10		(0.20)	
D1	1.10	1.30	N	6	
E	1.90	2.10	aaa	0.08	
E1	0.90	1.10	bbb	0.	10
е	0.	65			
K	0.05				
K1	0.26				
K2	0.42				
K3	0.10	0.30			

NOTE:
DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSION OR GATE BURRS

Figure 1 Outline PG-VSON-6, dimensions in mm

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ISK057N04LM6



Revision History

ISK057N04LM6

Revision: 2023-12-20, Rev. 2.2

Previous Revision

Revision	Date	Subjects (major changes since last revision)				
2.0	2022-12-23	Release of final version				
2.1	2023-04-20	Update RTHjc, current rating and Ptot.				
2.2	2023-12-20	Update POD drawing				

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